# INTEGRATED CIRCUITS

# DATA SHEET

74F242
Quad transceiver, inverting (3-State)
74F243
Quad transceiver (3-State)

Product specification

1990 Aug 31

IC15 Data Handbook

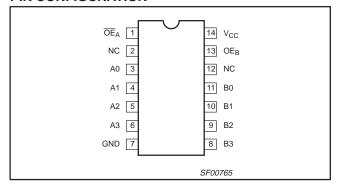




Transceivers 74F242/74F243

74F242 Quad Transceiver, Inverting (3-State) 74F243 Quad Transceiver (3-State)

## **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F242	4.3ns	31.2mA
74F243	4.0ns	66mA

## **ORDERING INFORMATION**

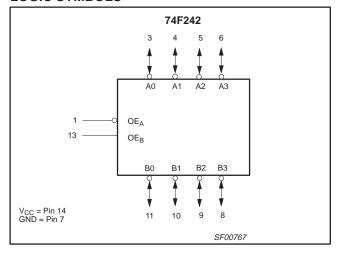
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG DWG#		
14-pin plastic DIP	N74F242N, N74F243N	SOT27-1		
14-pin plastic SO	N74F242D, N74F243D	SOT108-1		

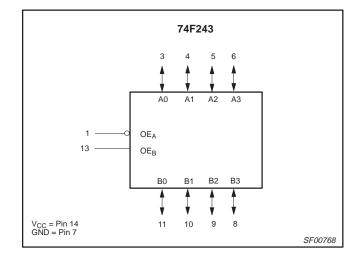
## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
An, Bn	Data inputs (74F242)	3.5/1.67	70μA/1.0mA
An, Bn	Data inputs (74F243)	3.5/2.67	70μA/1.6mA
<del>OE</del> <sub>A</sub>	Output enable input (active Low)	1.0/1.67	20μA/1.0mA
OE <sub>B</sub>	Output enable input	1.0/1.67	20μA/1.0mA
An, Bn	Data outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

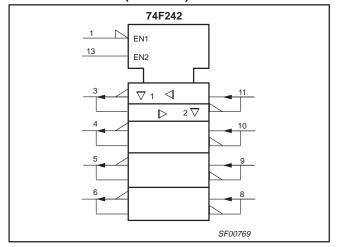
## **LOGIC SYMBOLS**

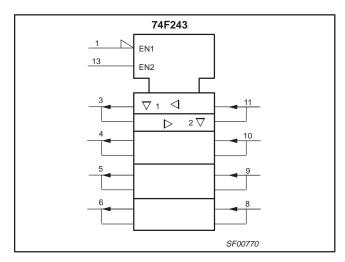


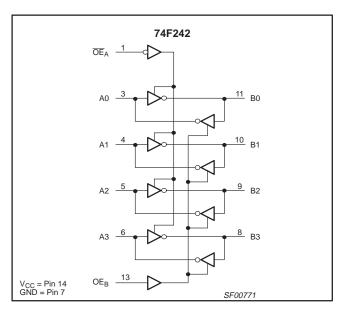


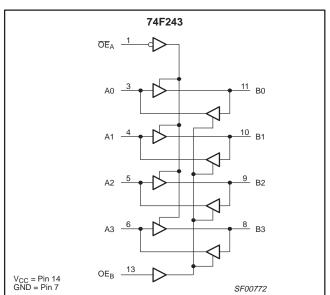
#### **Transceivers** 74F242/74F243

# LOGIC SYMBOLS (IEEE/IEC)









# **LOGIC DIAGRAMS FUNCTION TABLE, 74F242**

INP	JTS	OUTPUTS				
ŌĒĄ	OEB	An	Bn			
L	L	INPUT	B= <del>A</del>			
Н	L	Z	Z			
L	Н	а	а			
Н	Н	A=B	INPUT			

H = High voltage level

L = Low voltage level

Z = High impedance "off" state a = This condition is not allowed due to excessive currents

# **FUNCTION TABLE, 74F243**

INPL	JTS	OUTF	PUTS
<del>OE</del> <sub>A</sub>	OEB	An	Bn
L	L	INPUT	B=A
Н	L	Z	Z
L	Н	а	а
Н	Н	A=B	INPUT

3 1990 Aug 30

Transceivers 74F242/74F243

# **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	−0.5 to V <sub>CC</sub>	V
I <sub>OUT</sub>	Current applied to output in Low output state	128	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature	-65 to +150	°C

## **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT		
STWIBOL	PARAMETER	MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-15	mA
I <sub>OL</sub>	Low-level output current			64	mA
T <sub>amb</sub>	Operating free-air temperature range	0		70	°C

Transceivers 74F242/74F243

## DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDCI	DADAME	ren			et compition	-1		LIMITS		UNIT	
SYMBOL	PARAMET	IEK		"	ST CONDITION	MIN	TYP <sup>2</sup>	MAX	UNII		
				$V_{CC} = MIN,$		±10%V <sub>CC</sub>	2.4			.,	
				$V_{IL} = MAX,$ $V_{IH} = MIN$	$I_{OH} = -3mA$	±5%V <sub>CC</sub>	2.7	3.3		٧	
V <sub>OH</sub>	High-level output voltage	9		V <sub>CC</sub> = MIN,		±10%V <sub>CC</sub>	2.0	3.2			
				$V_{IL} = MAX,$ $V_{IH} = MIN$	$I_{OL} = -15 \text{mA}$	±5%V <sub>CC</sub>	2.0	3.1		V	
	l and land and and and and			$V_{CC} = MIN,$	1 MAAV	±10%V <sub>CC</sub>			0.55	V	
$V_{OL}$	Low-level output voltage			$V_{IL} = MAX,$ $V_{IH} = MIN$	I <sub>OH</sub> =MAX	±5%V <sub>CC</sub>		0.42	0.55		
V <sub>IK</sub>	Input clamp voltage			$V_{CC} = MIN, I_I$	= I <sub>IK</sub>			-0.73	-1.2	V	
I.	Input current at	A0-A3,	B0-B3	V <sub>CC</sub> = MAX,	$V_{CC} = MAX, V_I = 5.5V$				1	mA	
'1	maximum input voltage	ΘE <sub>A</sub> ,	OE <sub>B</sub>	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7.0V				100	μΑ	
I <sub>IH</sub>	High-level input current	OE <sub>A</sub> ,	$OE_A, OE_B$ $V_{CC} = MAX, VI =$						20	μΑ	
I <sub>IL</sub>	Low-level input current	onl	у	$V_{CC} = MAX, VI = 0.5V$					-1	mA	
I <sub>IH</sub> +I <sub>OZH</sub>	Off-state output current High-level voltage applie	ed		$V_{CC} = MAX, V_O = 2.7V$				70	μΑ		
1 .1	Off-state output current	74F2	242	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	$V_{CC} = MAX, V_O = 0.5V$				-1.0	1	
I <sub>IL</sub> +I <sub>OZL</sub>	Low-level voltage applied	74F2	243	$V_{CC} = MAX,$					-1.6	mA	
I <sub>OS</sub>	Short-circuit output curre	ent <sup>3</sup>		$V_{CC} = MAX$			-100		-225	mA	
			I <sub>CCH</sub>					22	35	mA	
		74F242	I <sub>CCL</sub>	$V_{CC} = MAX$				40	55	mA	
l	Supply current (total)		I <sub>CCZ</sub>					32	45	mA	
Icc	Supply current (total)		I <sub>CCH</sub>					64	80	mA	
		74F243 I <sub>CC</sub>	I <sub>CCL</sub>	V <sub>CC</sub> = MAX				64	90	mA	
			I <sub>CCZ</sub>	1				71	90	mA	

#### NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ .
- 3. Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

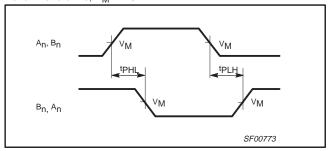
Transceivers 74F242/74F243

## **AC ELECTRICAL CHARACTERISTICS**

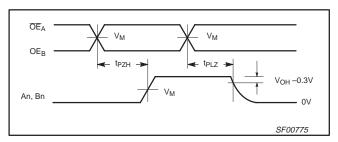
	SYMBOL PARAMETER					LIM	ITS		
SYMBOL			PARAMETER		TEST CONDITION	T <sub>a</sub> C <sub>L</sub> = 5	/ <sub>CC</sub> = +5\ <sub>mb</sub> = +25 0pF, R <sub>L</sub> =	/ °C : 500Ω	V <sub>CC</sub> = +5 T <sub>amb</sub> = 0°C C <sub>L</sub> = 50pF,
				MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn to Bn, An		Waveform NO TAG	2.5 2.0	3.5 3.0	6.0 4.5	2.5 2.0	7.0 4.5	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	74F242	Waveform 3 Waveform 4	3.0 3.5	4.0 6.5	7.0 9.0	3.0 3.5	8.0 10.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable time from High or Low level		Waveform 3 Waveform 4	3.5 3.5	5.5 6.0	8.5 9.5	3.5 3.5	9.0 11.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn to Bn, An		Waveform 2	2.5 2.5	4.0 4.0	5.2 5.2	2.0 2.0	6.2 6.5	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	74F243	Waveform 3 Waveform 4	2.0 2.0	4.5 5.0	5.7 7.5	2.0 2.0	6.7 8.5	ns
t <sub>PHZ</sub>	Output Disable time from High or Low level		Waveform 3 Waveform 4	2.0 2.0	4.0 4.5	6.0 6.0	2.0 2.0	7.0 7.0	ns

# **AC WAVEFORMS**

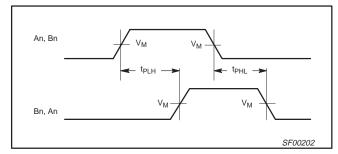
For all waveforms,  $V_M = 1.5V$ .



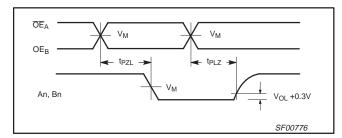
Waveform 1. For Inverting Outputs



Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



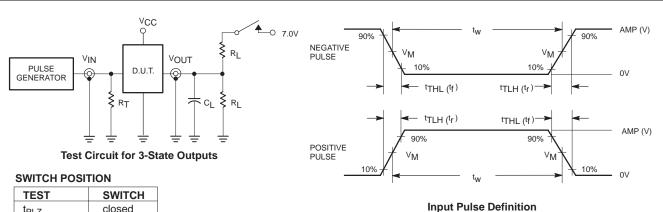
Waveform 2. For Non-Inverting Outputs



Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

**Transceivers** 74F242/74F243

## **TEST CIRCUIT AND WAVEFORMS**



TEST	SWITCH
t <sub>PLZ</sub>	closed
t <sub>PZL</sub>	closed
All other	open

## **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

see AC electrical characteristics for value.

Load capacitance includes jig and probe capacitance;
see AC electrical characteristics for value.

Termination resistance should be equal to  $Z_{\text{OUT}}$  of pulse generators.  $R_T =$ 

INPUT PULSE REQUIREMENTS										
lallilly	amplitude	$V_{\text{M}}$	rep. rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>				
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns				

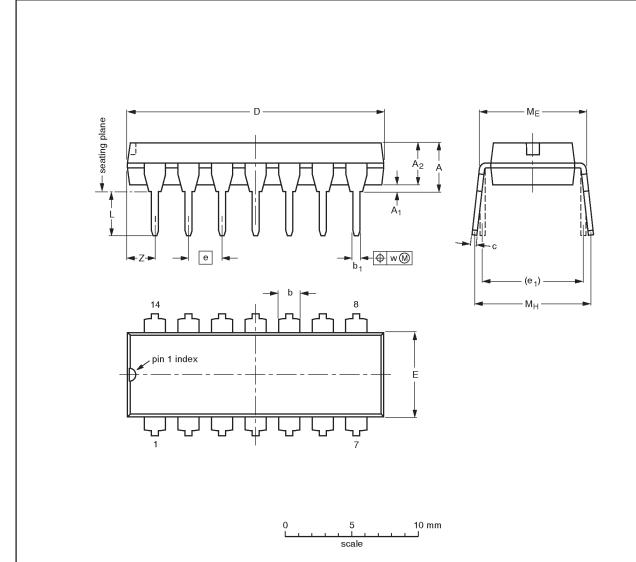
SF00777

7 1990 Aug 30

Transceivers 74F242, 74F243

# DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



# DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

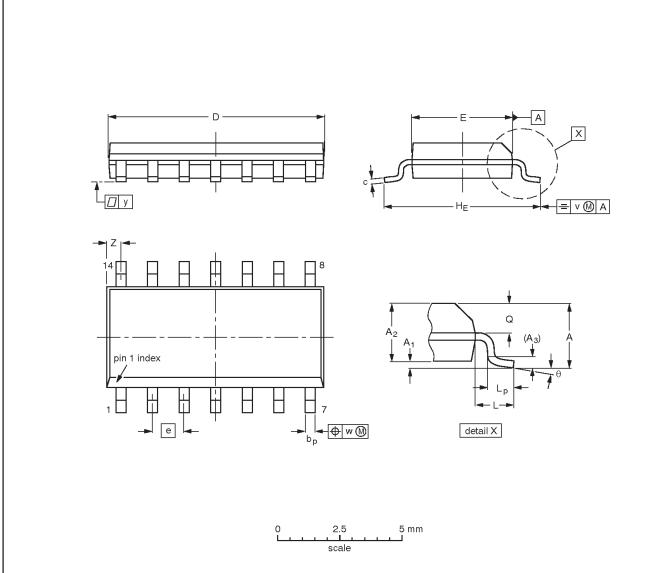
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001AA				<del>92-11-17</del> 95-03-11

Transceivers 74F242, 74F243

# SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	o°

## Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB				<del>95-01-23</del> 97-05-22

1990 Aug 30

Transceivers 74F242, 74F243

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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